

C0402C121MATAC7411

SMD Comm X8G HT150C, Ceramic, 120 pF, 20%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0402, 0.3 mm



General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	1.06 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		
Chip Size	0402	
L	1mm +/-0.05mm	
W	0.5mm +/-0.05mm	
т	0.5mm +/-0.05mm	
S	0.3mm MIN	
В	0.3mm +/-0.1mm	

Packaging Specifications

Packaging T&R, 330mm, Paper	Tape
Packaging Quantity 50000	

Specifications	
Capacitance	120 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	20%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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